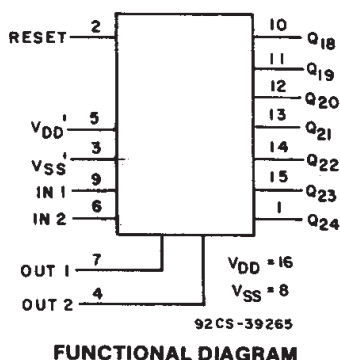


# CD4521B Types

## CMOS 24-Stage Frequency Divider

High-Voltage Types (20-Volt Rating)

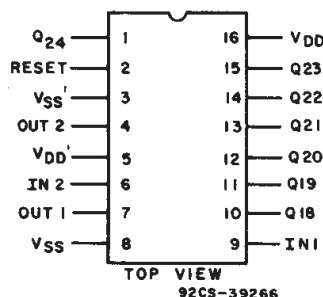


### Features:

- Reset disables the RC oscillator for low-power standby condition
- $V_{DD}$  and  $V_{SS}$  pins are brought out from the crystal oscillator to allow use of external resistors for low-power operation
- Maximum input current of 1  $\mu$ A at 18 V over full package-temperature range: 100 nA at 18 V and 25°C
- Common reset
- 100% tested for 20-V quiescent current
- 5, 10 and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Meets all requirements of JEDEC Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

■ CD4521B consists of an oscillator section and 24 ripple-carry binary counter stages. The oscillator configuration (using IN1) allows design of either RC or crystal oscillator circuits. IN1 should be tied either HIGH or LOW when not in use. A HIGH on the RESET causes the counter to go to the all-0's state and disables the oscillator. The count is advanced on the negative transition of IN1 (and IN2). A time-saving test mode is described in the Functional Test Sequence Table and in Fig. 6.

The CD4521B types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).



### TERMINAL ASSIGNMENT

| OUTPUT | COUNT CAPACITY               |
|--------|------------------------------|
| Q18    | 2 <sup>18</sup> = 262,144    |
| Q19    | 2 <sup>19</sup> = 524,288    |
| Q20    | 2 <sup>20</sup> = 1,048,576  |
| Q21    | 2 <sup>21</sup> = 2,097,152  |
| Q22    | 2 <sup>22</sup> = 4,194,304  |
| Q23    | 2 <sup>23</sup> = 8,388,608  |
| Q24    | 2 <sup>24</sup> = 16,777,216 |

### MAXIMUM RATINGS, Absolute-Maximum Values:

#### DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ )

Voltages referenced to  $V_{SS}$  Terminal) ..... -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS ..... -0.5V to  $V_{DD}$  + 0.5V

DC INPUT CURRENT, ANY ONE INPUT .....  $\pm 10$ mA

#### POWER DISSIPATION PER PACKAGE ( $P_D$ ):

For  $T_A$  = -55°C to +100°C ..... 500mW

For  $T_A$  = +100°C to +125°C ..... Derate Linearly at 12mW/°C to 200mW

#### DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR  $T_A$  = FULL PACKAGE-TEMPERATURE RANGE (All Package Types) ..... 100mW

OPERATING-TEMPERATURE RANGE ( $T_A$ ) ..... -55°C to +125°C

STORAGE TEMPERATURE RANGE ( $T_{sto}$ ) ..... -65°C to +150°C

#### LEAD TEMPERATURE (DURING SOLDERING):

At distance 1/16  $\pm$  1/32 inch (1.59  $\pm$  0.79mm) from case for 10s max ..... +265°C

# CD4521B Types

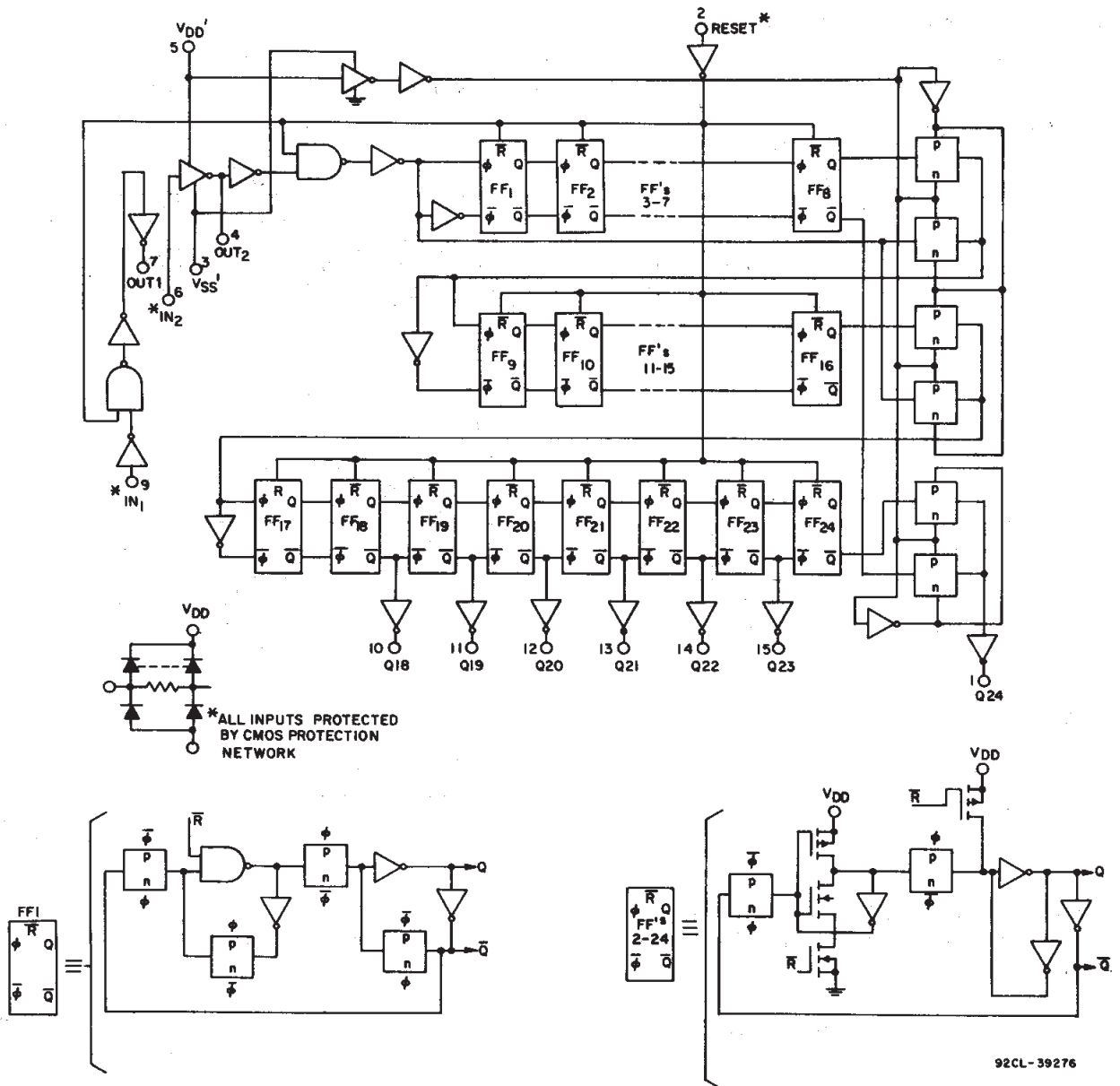


Fig. 1 - Logic diagram for CD4521B.

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COMMERCIAL CMOS  
HIGH VOLTAGE ICs

# CD4521B Types

## STATIC ELECTRICAL CHARACTERISTICS

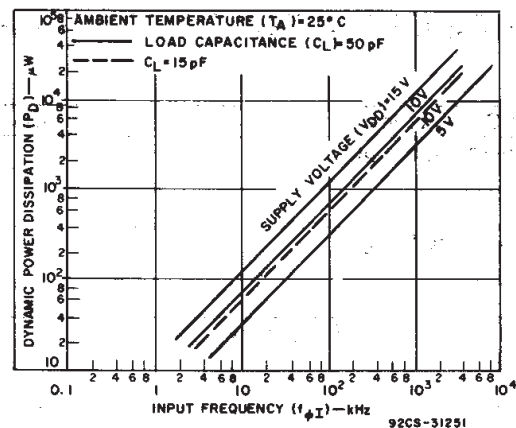
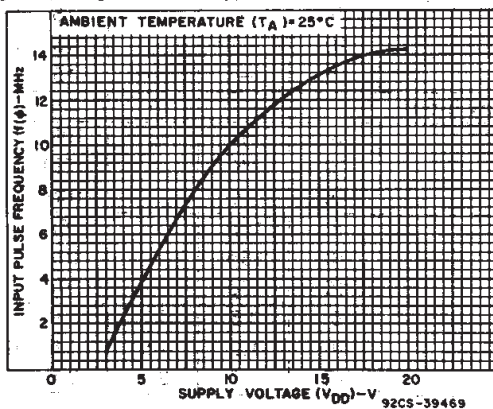
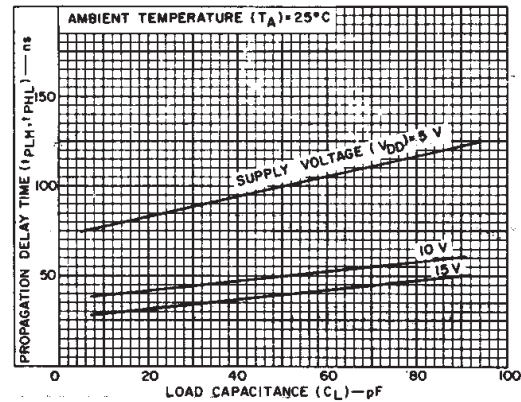
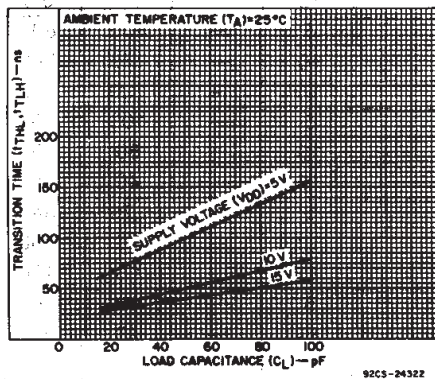
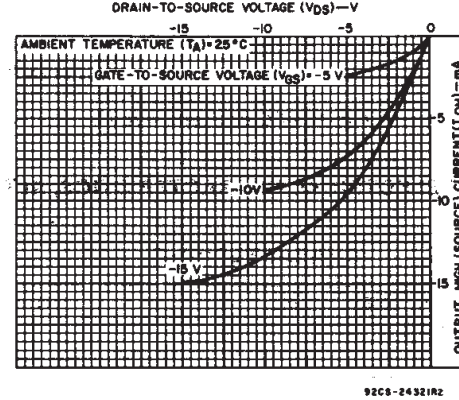
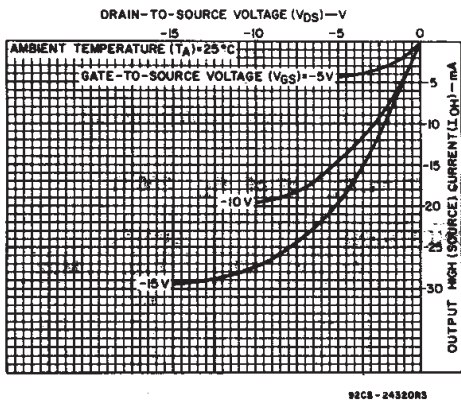
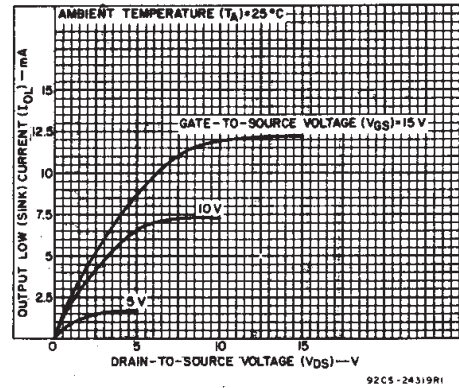
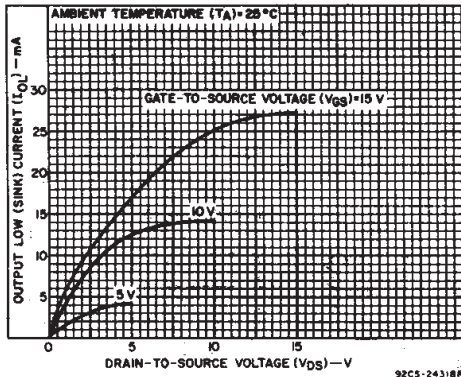
| CHARACTERISTIC                                     | CONDITIONS            |                        |                        | LIMITS AT INDICATED TEMPERATURES (°C) |       |       |       |       |                   |      | UNITS |
|----------------------------------------------------|-----------------------|------------------------|------------------------|---------------------------------------|-------|-------|-------|-------|-------------------|------|-------|
|                                                    | V <sub>O</sub><br>(V) | V <sub>IN</sub><br>(V) | V <sub>DD</sub><br>(V) | -55                                   | -40   | +85   | +125  | +25   |                   |      |       |
|                                                    |                       |                        |                        |                                       |       |       |       | Min.  | Typ.              | Max. |       |
| Quiescent Device Current, I <sub>DD</sub> Max.     | —                     | 0, 5                   | 5                      | 5                                     | 5     | 150   | 150   | —     | 0.04              | 5    | μA    |
|                                                    | —                     | 0, 10                  | 10                     | 10                                    | 10    | 300   | 300   | —     | 0.04              | 10   |       |
|                                                    | —                     | 0, 15                  | 15                     | 20                                    | 20    | 600   | 600   | —     | 0.04              | 20   |       |
|                                                    | —                     | 0, 20                  | 20                     | 100                                   | 100   | 3000  | 3000  | —     | 0.08              | 100  |       |
| Output Low (Sink) Current, I <sub>OL</sub> Min.    | 0.4                   | 0, 5                   | 5                      | 0.64                                  | 0.61  | 0.42  | 0.36  | 0.51  | 1                 | —    | mA    |
|                                                    | 0.5                   | 0, 10                  | 10                     | 1.6                                   | 1.5   | 1.1   | 0.9   | 1.3   | 2.6               | —    |       |
|                                                    | 1.5                   | 0, 15                  | 15                     | 4.2                                   | 4     | 2.8   | 2.4   | 3.4   | 6.8               | —    |       |
| Output High (Source) Current, I <sub>OH</sub> Min. | 4.6                   | 0, 5                   | 5                      | -0.64                                 | -0.61 | -0.42 | -0.36 | -0.51 | -1                | —    |       |
|                                                    | 2.5                   | 0, 5                   | 5                      | -2                                    | -1.8  | -1.3  | -1.15 | -1.6  | -3.2              | —    |       |
|                                                    | 9.5                   | 0, 10                  | 10                     | -1.6                                  | -1.5  | -1.1  | -0.9  | -1.3  | -2.6              | —    |       |
|                                                    | 13.5                  | 0, 15                  | 15                     | -4.2                                  | -4    | -2.8  | -2.4  | -3.4  | -6.8              | —    |       |
| Output Voltage: Low-Level, V <sub>OL</sub> Max.    | —                     | 0, 5                   | 5                      | 0.05                                  |       |       |       | —     | 0                 | 0.05 | V     |
|                                                    | —                     | 0, 10                  | 10                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |       |
|                                                    | —                     | 0, 15                  | 15                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |       |
| Output Voltage: High-Level, V <sub>OH</sub> Min.   | —                     | 0, 5                   | 5                      | 4.95                                  |       |       |       | 4.95  | 5                 | —    |       |
|                                                    | —                     | 0, 10                  | 10                     | 9.95                                  |       |       |       | 9.95  | 10                | —    |       |
|                                                    | —                     | 0, 15                  | 15                     | 14.95                                 |       |       |       | 14.95 | 15                | —    |       |
| Input Low Voltage, V <sub>IL</sub> Max.            | 0.5, 4.5              | —                      | 5                      | 1.5                                   |       |       |       | —     | —                 | 1.5  |       |
|                                                    | 1, 9                  | —                      | 10                     | 3                                     |       |       |       | —     | —                 | 3    |       |
|                                                    | 1.5, 13.5             | —                      | 15                     | 4                                     |       |       |       | —     | —                 | 4    |       |
| Input High Voltage, V <sub>IH</sub> Min.           | 0.5, 4.5              | —                      | 5                      | 3.5                                   |       |       |       | 3.5   | —                 | —    |       |
|                                                    | 1, 9                  | —                      | 10                     | 7                                     |       |       |       | 7     | —                 | —    |       |
|                                                    | 1.5, 13.5             | —                      | 15                     | 11                                    |       |       |       | 11    | —                 | —    |       |
| Input Current, I <sub>IN</sub> Max.                | —                     | 0, 18                  | 18                     | ±0.1                                  | ±0.1  | ±1    | ±1    | —     | ±10 <sup>-5</sup> | ±0.1 | μA    |

## RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operating is always within the following ranges:

| CHARACTERISTIC                                                             | V <sub>DD</sub><br>(V) | LIMITS |      | UNITS    |
|----------------------------------------------------------------------------|------------------------|--------|------|----------|
|                                                                            |                        | Min.   | Max. |          |
| Supply-Voltage Range (For T <sub>A</sub> = Full Package-Temperature Range) | —                      | 3      | 18   | V        |
| Input Pulse Width $t_{w\phi}$                                              | 5                      | 340    | —    | ns       |
|                                                                            | 10                     | 150    | —    |          |
|                                                                            | 15                     | 120    | —    |          |
| Reset Pulse Width $t_{w(R)}$                                               | 5                      | 180    | —    | ns       |
|                                                                            | 10                     | 80     | —    |          |
|                                                                            | 15                     | 50     | —    |          |
| Input Pulse Frequency $f\phi$                                              | 5                      | —      | 2    | MHz      |
|                                                                            | 10                     | —      | 5    |          |
|                                                                            | 15                     | —      | 6.5  |          |
| Input Pulse Rise or Fall Time $t_r\phi, t_f\phi$                           | 5                      | —      | 15   | $\mu$ s  |
|                                                                            | 10                     | —      | 15   |          |
|                                                                            | 15                     | —      | 15   |          |
| R <sub>T</sub> Operating Range                                             | 5                      | 1K     | 10M  | $\Omega$ |
|                                                                            | 10                     | 1K     | 10M  |          |
|                                                                            | 15                     | 1K     | 10M  |          |
| C <sub>T</sub> Operating Range                                             | 5                      | 15p    | 10M  | F        |
|                                                                            | 10                     | 15p    | 10M  |          |
|                                                                            | 15                     | 15p    | 10M  |          |

## CD4521B Types



## CD4521B Types

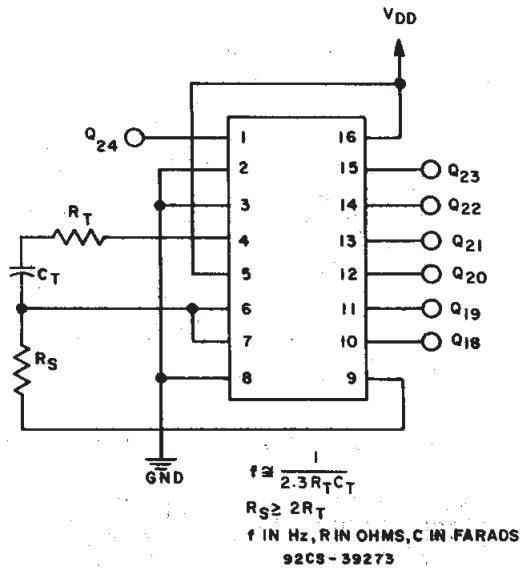


Fig. 10 - RC oscillator circuit.

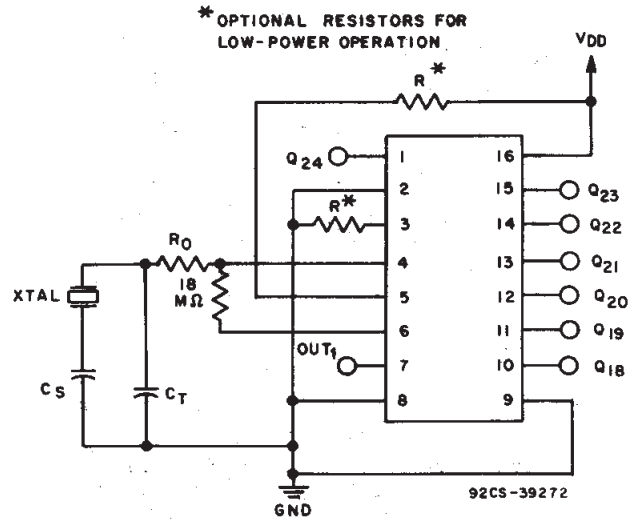


Fig. 11 - Crystal oscillator circuit.

**DYNAMIC ELECTRICAL CHARACTERISTICS, At  $T_A = 25^\circ\text{C}$ ; Input  $t_r, t_f = 20\text{ ns}$ ,  $C_L = 50\text{ pF}$ ,  $R_L = 200\ \Omega$**

| CHARACTERISTIC                          | TEST CONDITIONS                                                         | LIMITS      |      |      |          | UNITS         |
|-----------------------------------------|-------------------------------------------------------------------------|-------------|------|------|----------|---------------|
|                                         |                                                                         | $V_{DD}(V)$ | Min. | Typ. | Max.     |               |
| Propagation Delay Time:<br>Input to Q18 | $t_{PLH}, t_{PHL}$                                                      | 5           | —    | 4.5  | 9        | $\mu\text{s}$ |
|                                         |                                                                         | 10          | —    | 1.7  | 3.5      |               |
|                                         |                                                                         | 15          | —    | 1.3  | 2.7      |               |
| Input to Q24                            |                                                                         | 5           | —    | 6    | 12       | $\mu\text{s}$ |
|                                         |                                                                         | 10          | —    | 2.2  | 4.5      |               |
|                                         |                                                                         | 15          | —    | 1.7  | 3.5      |               |
| Reset to Qn                             |                                                                         | 5           | —    | 400  | 800      | $\mu\text{s}$ |
|                                         |                                                                         | 10          | —    | 170  | 340      |               |
|                                         |                                                                         | 15          | —    | 120  | 240      |               |
| Transition Time*                        | $t_{HL}, t_{LH}$                                                        | 5           | —    | 100  | 200      | $\text{ns}$   |
|                                         |                                                                         | 10          | —    | 50   | 100      |               |
|                                         |                                                                         | 15          | —    | 40   | 80       |               |
| Minimum Input Pulse Width               | $t_{w\phi}$                                                             | 5           | —    | 170  | 340      | $\text{ns}$   |
|                                         |                                                                         | 10          | —    | 75   | 150      |               |
|                                         |                                                                         | 15          | —    | 60   | 120      |               |
| Minimum Reset Pulse Width               | $t_{w(R)}$                                                              | 5           | —    | 90   | 180      | $\text{ns}$   |
|                                         |                                                                         | 10          | —    | 40   | 80       |               |
|                                         |                                                                         | 15          | —    | 25   | 50       |               |
| Maximum Input Pulse Frequency           | $f\phi$                                                                 | 5           | 2    | 4    | —        | $\text{MHz}$  |
|                                         |                                                                         | 10          | 5    | 10   | —        |               |
|                                         |                                                                         | 15          | 6.5  | 13   | —        |               |
| Input Pulse Rise or Fall Time           | $t_r\phi, t_f\phi$                                                      | 5           | —    | —    | 15       | $\mu\text{s}$ |
|                                         |                                                                         | 10          | —    | —    | 15       |               |
|                                         |                                                                         | 15          | —    | —    | 15       |               |
| Input Capacitance                       | $C_{IN}$                                                                | Any Input   | —    | 5    | 7.5      | $\text{pF}$   |
| $R_T$ Operating Range                   |                                                                         | 5           | 1K   | —    | 10M      | $\Omega$      |
|                                         |                                                                         | 10          | 1K   | —    | 10M      |               |
|                                         |                                                                         | 15          | 1K   | —    | 10M      |               |
| $C_T$ Operating Range                   |                                                                         | 5           | 15p  | —    | 10 $\mu$ | $\text{F}$    |
|                                         |                                                                         | 10          | 15p  | —    | 10 $\mu$ |               |
|                                         |                                                                         | 15          | 15p  | —    | 10 $\mu$ |               |
| Maximum Oscillator Frequency            | $R_T=1\text{ K}\Omega$<br>$C_T=15\text{ pF}$<br>$R_S=30\text{ K}\Omega$ | 5           | 0.5  | 0.7  | 0.9      | $\text{MHz}$  |
|                                         |                                                                         | 10          | 1.2  | 1.5  | 1.8      |               |
|                                         |                                                                         | 15          | 1.7  | 2.1  | 2.5      |               |

\*Not applicable for pin 4 (OUT2).

## CD4521B Types

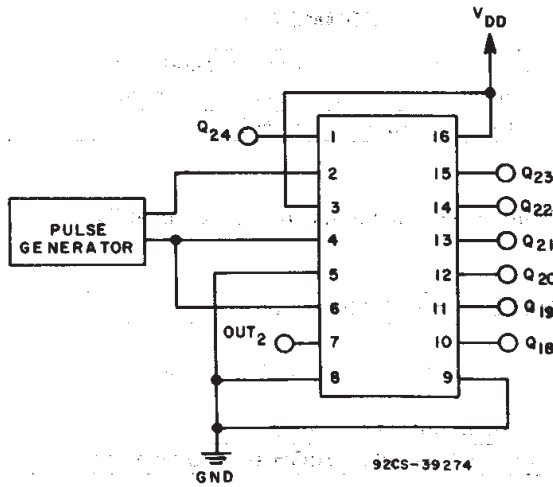


Fig. 12 - Functional test circuit.

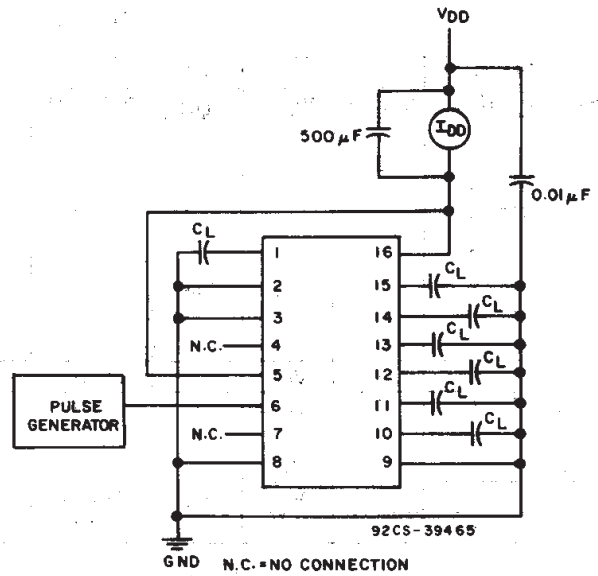


Fig. 13 - Dynamic power dissipation test circuit.

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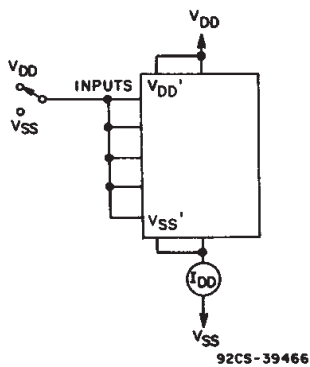


Fig. 14 - Quiescent device current.

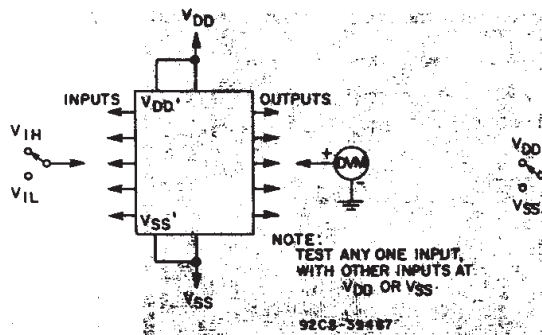


Fig. 15 - Input voltage.

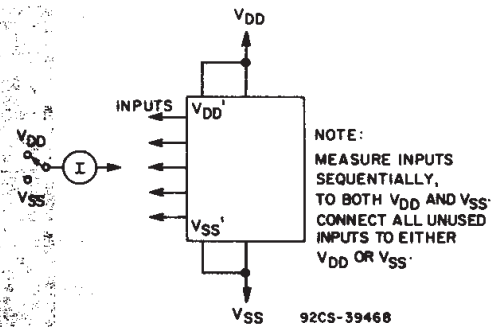


Fig. 16 - Input current.

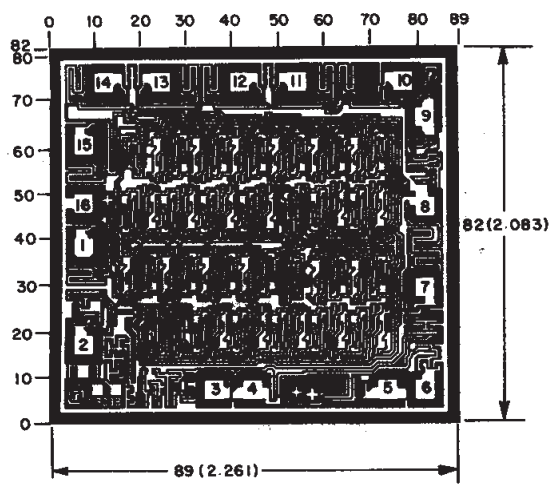
## CD4521B Types

### FUNCTIONAL TEST SEQUENCE

| INPUTS |                       | OUTPUTS               |                 |                 |         | COMMENTS                                                                                                   |
|--------|-----------------------|-----------------------|-----------------|-----------------|---------|------------------------------------------------------------------------------------------------------------|
| RESET  | IN 2                  | OUT 2                 | V <sub>SS</sub> | V <sub>DD</sub> | Q18-Q24 |                                                                                                            |
| 1      | 0                     | 0                     | V <sub>DD</sub> | V <sub>SS</sub> | LOW     | Counter is in three 8-stage sections in parallel mode. Counter is reset. IN 2 and OUT 2 are tied together. |
| 0      | 1                     | 1                     | V <sub>DD</sub> | V <sub>SS</sub> |         | First LOW-to-HIGH transition at IN 2.                                                                      |
| 0      | 0<br>1<br>—<br>—<br>— | 0<br>1<br>—<br>—<br>— | V <sub>DD</sub> | V <sub>SS</sub> |         | 255 LOW-to-HIGH transitions are clocked in at IN 2.                                                        |
| 0      | 1                     | 1                     | V <sub>DD</sub> | V <sub>SS</sub> | HIGH    | The 255th LOW-to-HIGH transition.                                                                          |
| 0      | 0                     | 0                     | V <sub>DD</sub> | V <sub>SS</sub> | HIGH    | Counter is converted back to 24-stage serial-mode operation.                                               |
| 0      | 0                     | 0                     | V <sub>SS</sub> | V <sub>SS</sub> | HIGH    |                                                                                                            |
| 0      | 1                     | 0                     | V <sub>SS</sub> | V <sub>DD</sub> | HIGH    |                                                                                                            |
| 0      | 1                     |                       | V <sub>SS</sub> | V <sub>DD</sub> | HIGH    | OUT 2 reverts to output operation.                                                                         |
| 0      | 0                     |                       | V <sub>SS</sub> | V <sub>DD</sub> | LOW     | Counter ripples from an all-HIGH state to an all-LOW state.                                                |

A test function, which divides, has been included to reduce the time required to test all 24 stages of the counter. Three sections are loaded in parallel to 255 counts, forcing all the outputs to be in the HIGH state. The counter is changed

back to serial-mode operation and one additional LOW-to-HIGH transition is entered at IN 2, which causes the outputs to ripple from an all-HIGH state to an all-LOW state.



Dimensions and pad layout for CD4521BH.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| CD4521BE         | ACTIVE        | PDIP         | N                  | 16   | 25             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | -55 to 125   | CD4521BE                | <a href="#">Samples</a> |
| CD4521BEE4       | ACTIVE        | PDIP         | N                  | 16   | 25             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | -55 to 125   | CD4521BE                | <a href="#">Samples</a> |
| CD4521BM         | ACTIVE        | SOIC         | D                  | 16   | 40             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | CD4521BM                | <a href="#">Samples</a> |
| CD4521BM96       | ACTIVE        | SOIC         | D                  | 16   | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | CD4521BM                | <a href="#">Samples</a> |
| CD4521BM96G4     | ACTIVE        | SOIC         | D                  | 16   | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | CD4521BM                | <a href="#">Samples</a> |
| CD4521BMT        | ACTIVE        | SOIC         | D                  | 16   | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | CD4521BM                | <a href="#">Samples</a> |
| CD4521BNSR       | ACTIVE        | SO           | NS                 | 16   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | CD4521B                 | <a href="#">Samples</a> |
| CD4521BPW        | ACTIVE        | TSSOP        | PW                 | 16   | 90             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | CM521B                  | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

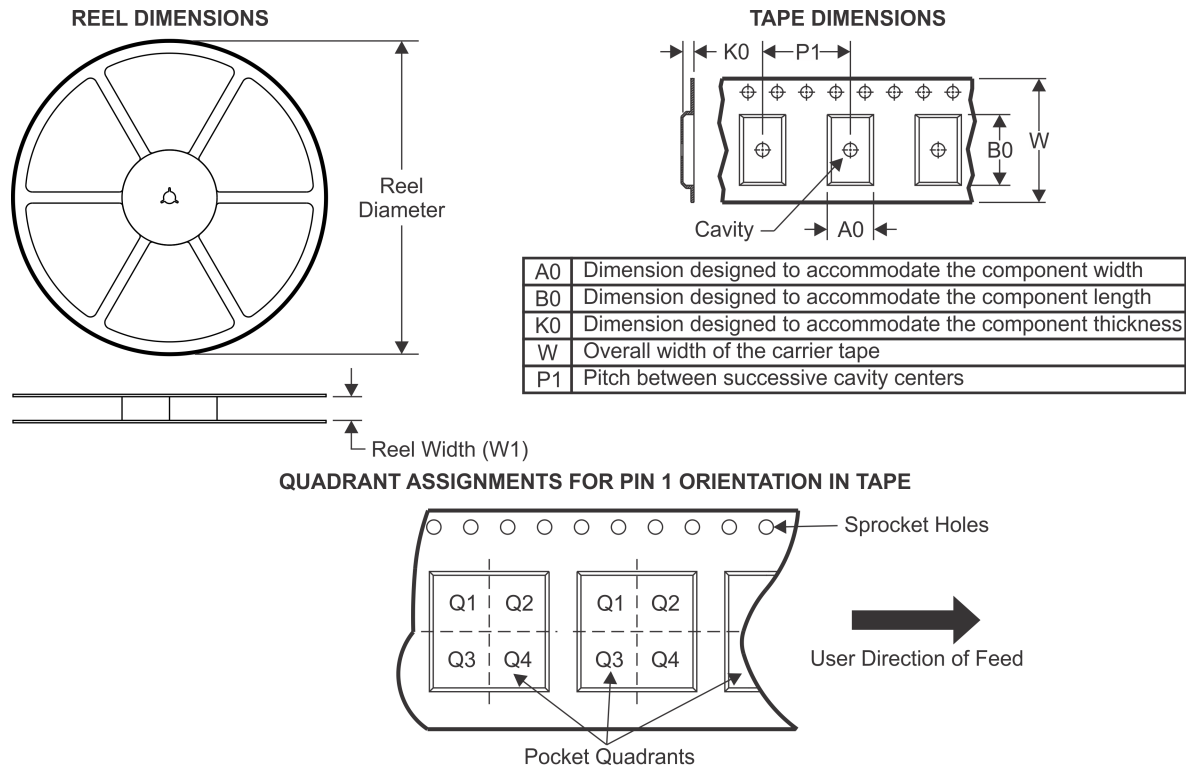
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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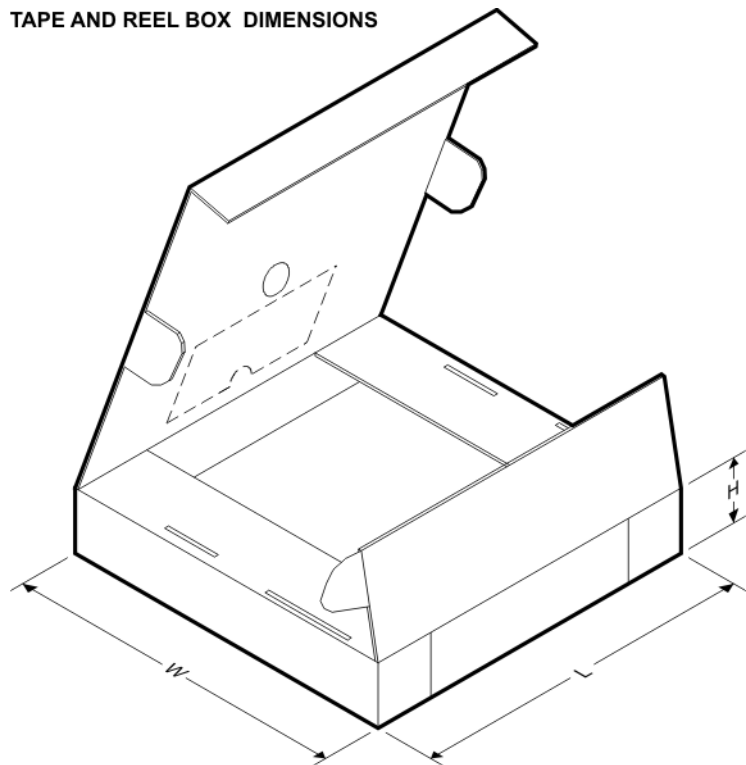
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD4521BM96 | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD4521BNSR | SO           | NS              | 16   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |

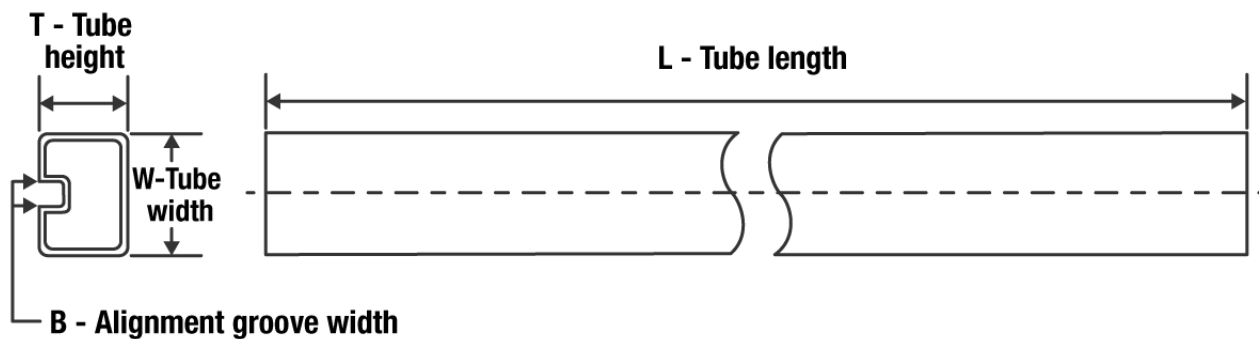
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD4521BM96 | SOIC         | D               | 16   | 2500 | 340.5       | 336.1      | 32.0        |
| CD4521BNSR | SO           | NS              | 16   | 2000 | 853.0       | 449.0      | 35.0        |

## TUBE

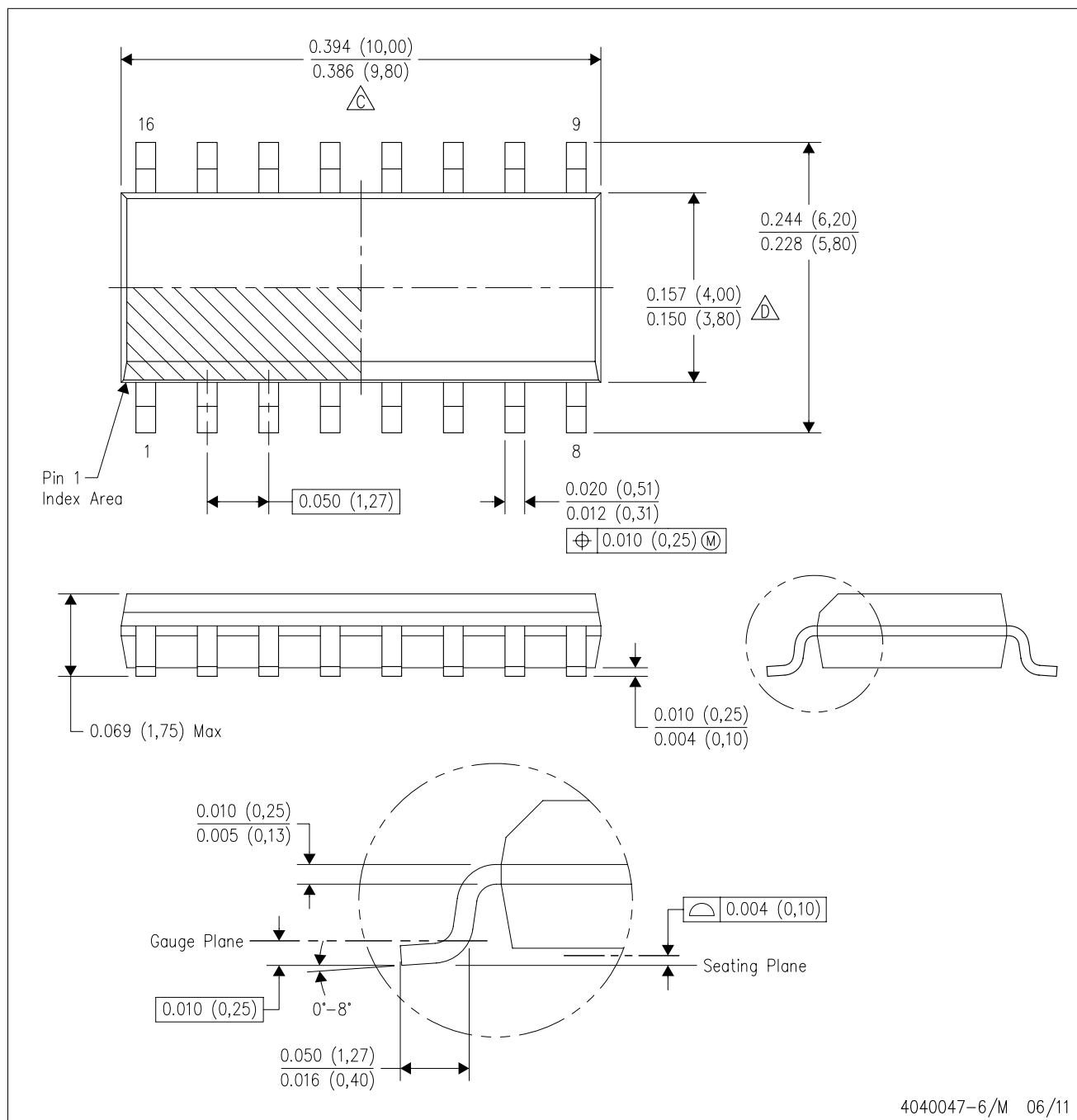


\*All dimensions are nominal

| Device     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD4521BE   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD4521BE   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD4521BEE4 | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD4521BEE4 | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD4521BM   | D            | SOIC         | 16   | 40  | 507    | 8      | 3940   | 4.32   |
| CD4521BPW  | PW           | TSSOP        | 16   | 90  | 530    | 10.2   | 3600   | 3.5    |

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE

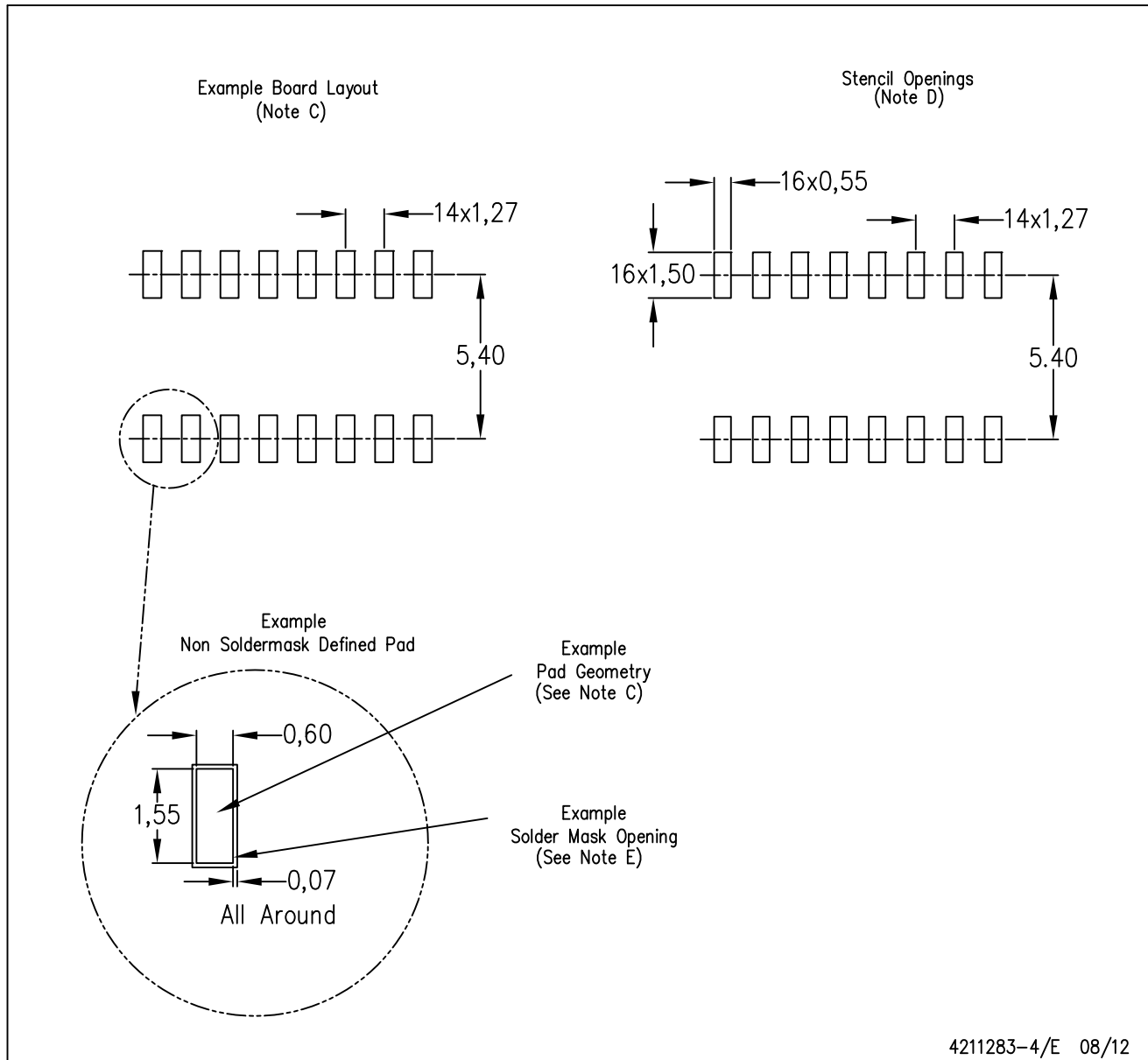


4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AC.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

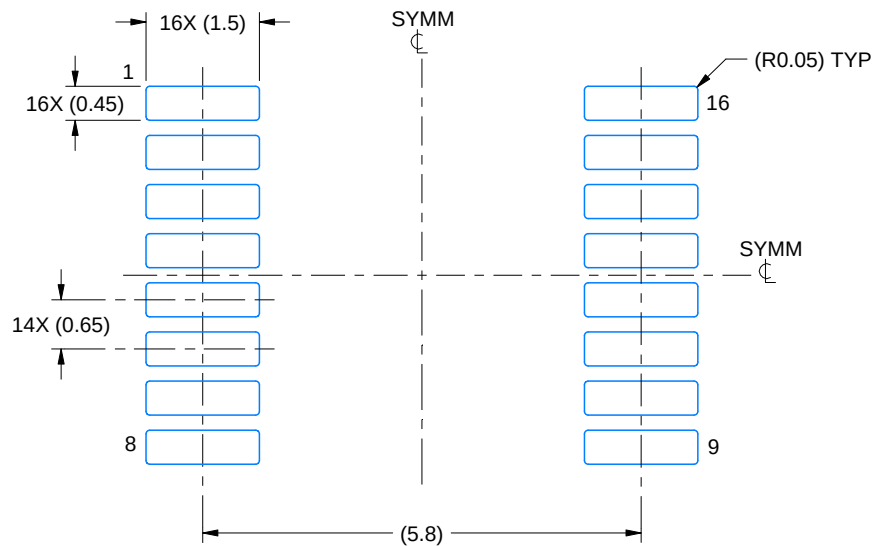


# EXAMPLE BOARD LAYOUT

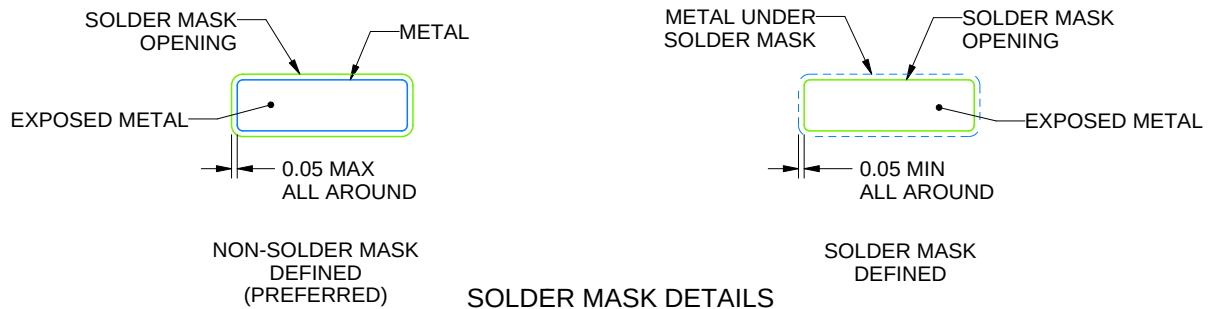
PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220204/A 02/2017

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

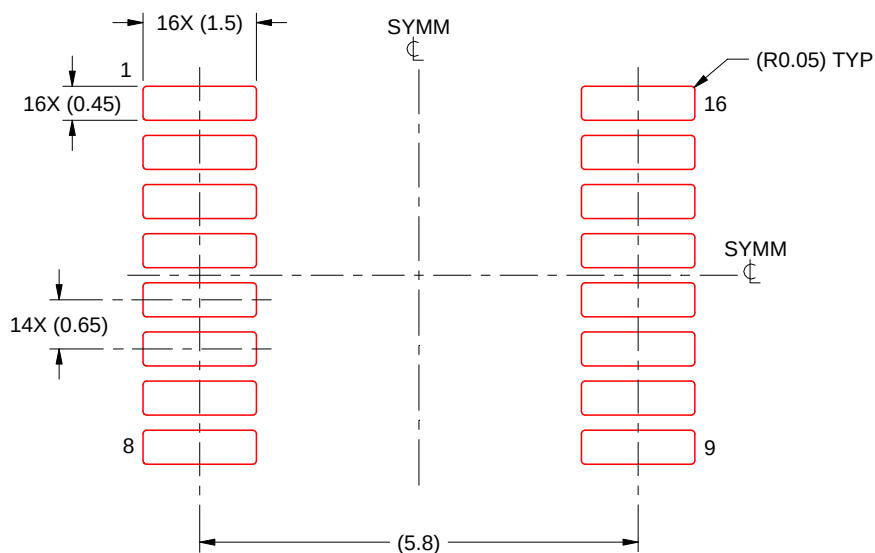
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220204/A 02/2017

NOTES: (continued)

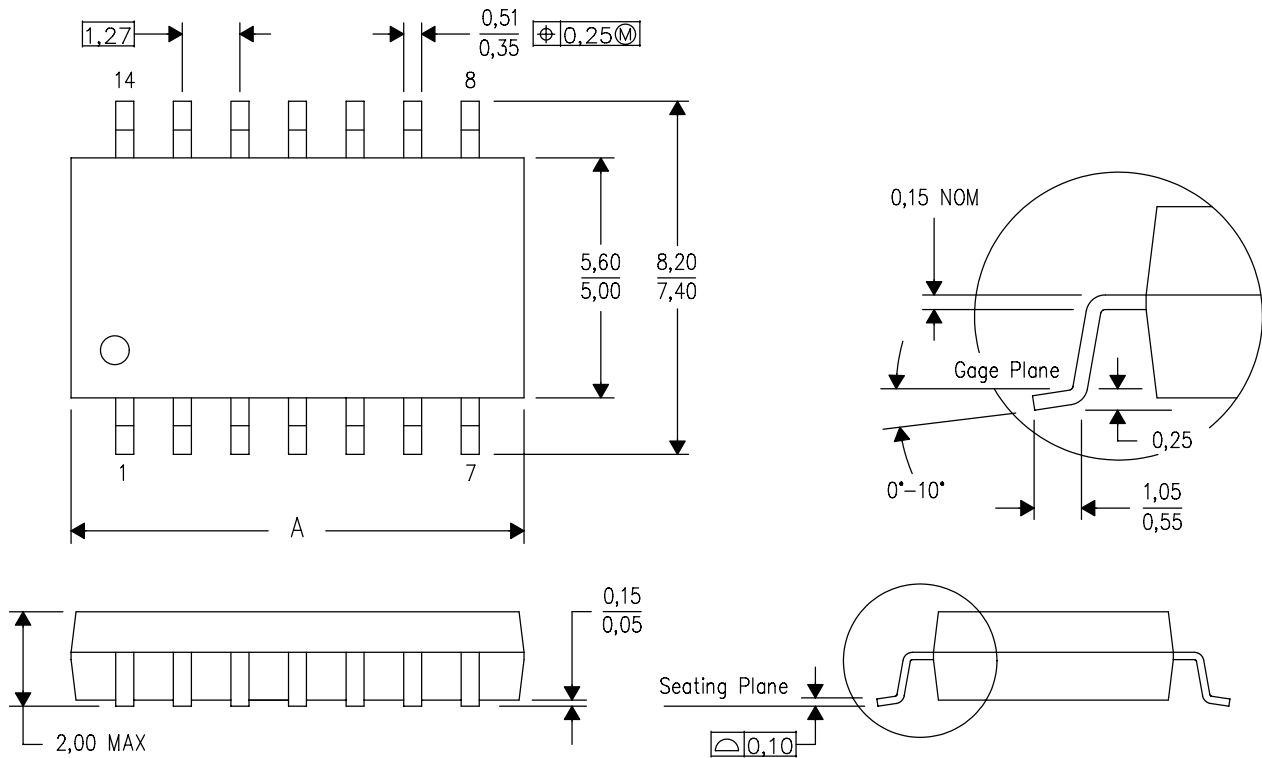
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



| DIM \ PINS ** | 14    | 16    | 20    | 24    |
|---------------|-------|-------|-------|-------|
| A MAX         | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN         | 9,90  | 9,90  | 12,30 | 14,70 |

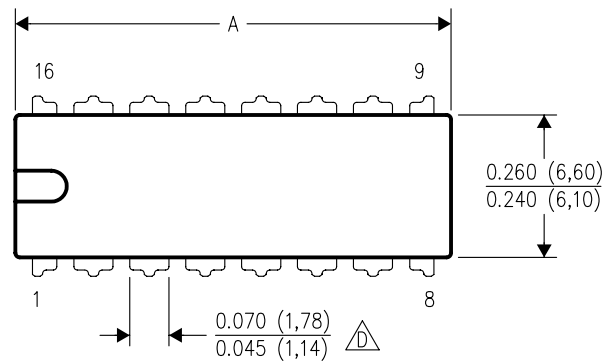
4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

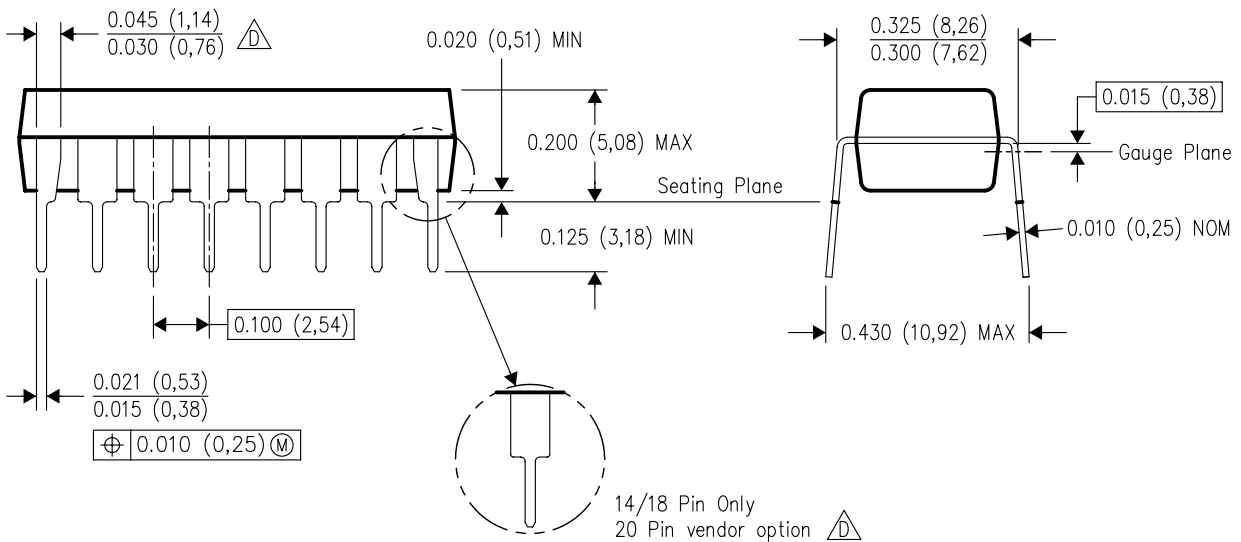
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



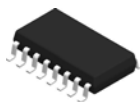
| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



14/18 Pin Only  
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

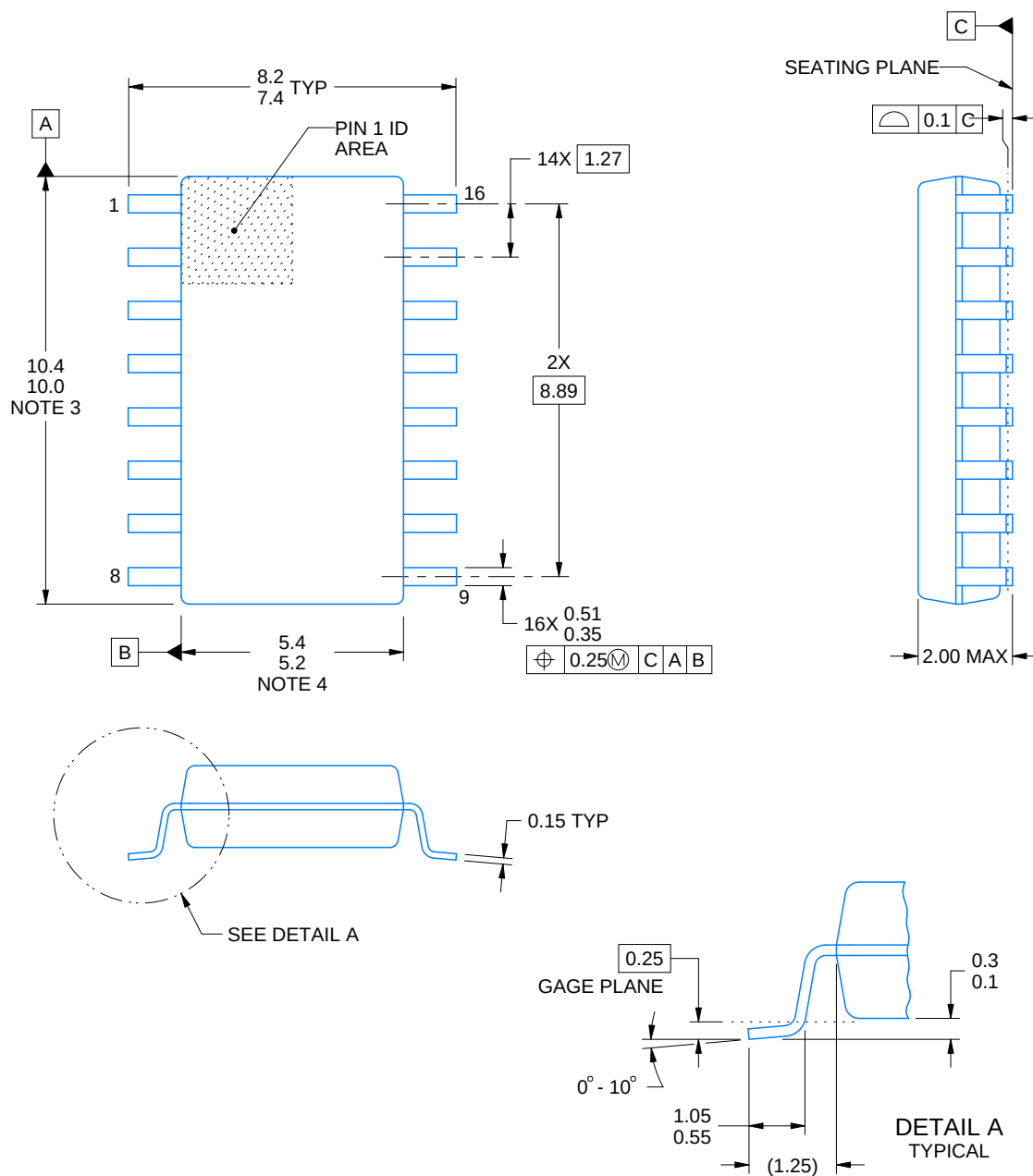


NS0016A

# PACKAGE OUTLINE

SOP - 2.00 mm max height

SOP



4220735/A 12/2021

## NOTES:

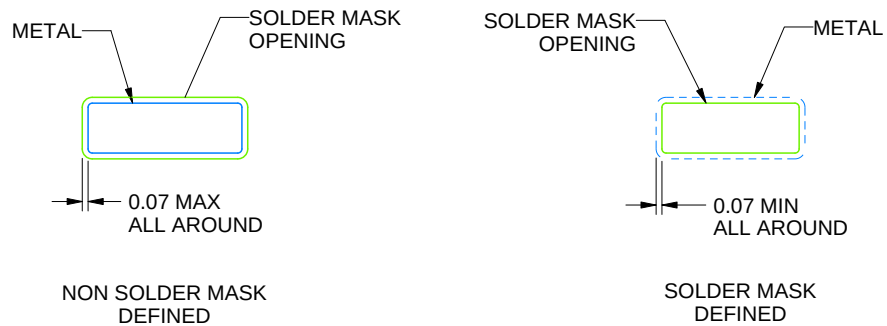
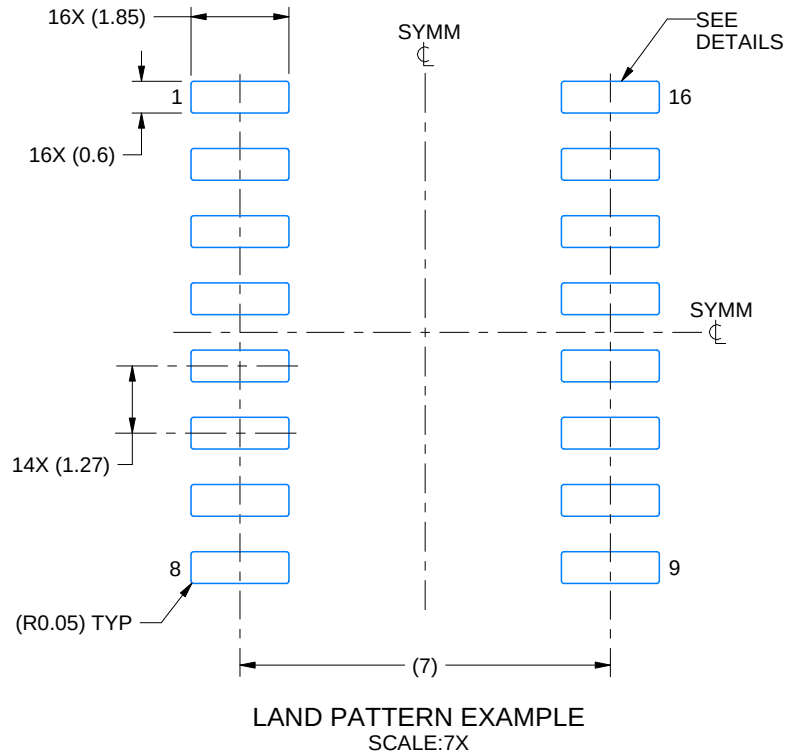
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

# EXAMPLE BOARD LAYOUT

NS0016A

SOP - 2.00 mm max height

SOP



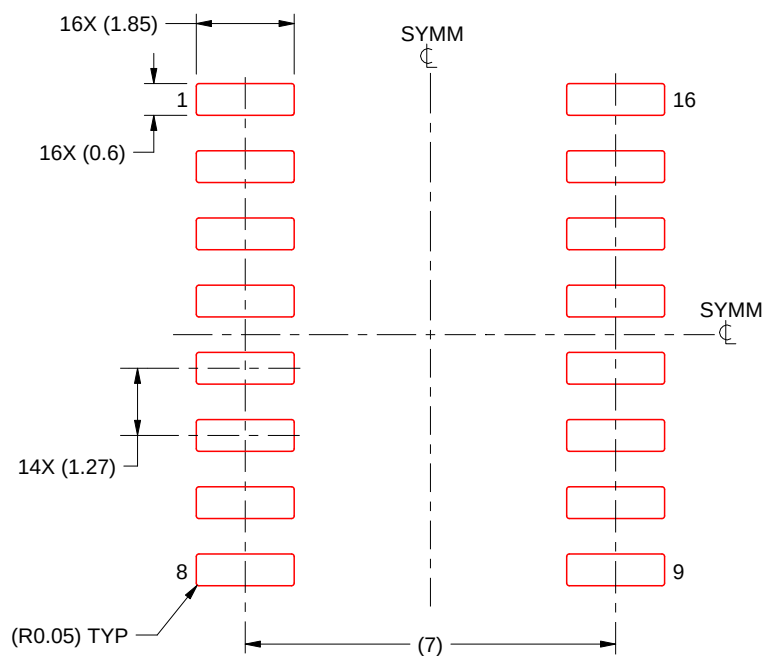
SOLDER MASK DETAILS

4220735/A 12/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE  
 BASED ON 0.125 mm THICK STENCIL  
 SCALE:7X

4220735/A 12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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